(Use several sheets if necessary)

Atty. Docket No. Serial No. INTEL/16652 10/664,475

Applicant Towle et al.

Filing Date Group Art Unit

2811

9-17-2003

U.S. PATENT DOCUMENTS									
*EXAMINER INITIALS	DOCUMEN' NUMBER	ISSUE DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE			

FOREIGN PATENT DOCUMENTS								
*Examiner	Document	Publication	Country	Class	Subclass	Translation		
Initials	Number	Date			}	Yes	No	
•								

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)				
a	Baggs, J; Machon, W; Magill, P; Mis, J; Rinne, G. "Solder Alloy Selection for Flip Chip on Board." International Material and Packaging Society Symposium, Brasleton, Georgia. February 1998. Pages 1-5.			
a	Bogaerts, W; Bienstman, P; Baets, R. "Sidewall Roughness in Photonic Crystal Slabs: A Comparison of High-Contrast Membranes and Low-Contrast III-V Epitaxial Structures." 11 th International Workshop on Optical Waveguide Theory and Numerical Modelling, April 4-5, 2003, Prague, Czech Republic. Pages 1-4.			
a	"Polymer Technology Overview." Optical Crosslinks, Incorporated. 2001. Pages 1-10. Retrieved from internet: <url: <a="" href="http://www.opticalcrosslinks.com/pdf/WebPolymerTECHNOLOGYPlatform.pdf">http://www.opticalcrosslinks.com/pdf/WebPolymerTECHNOLOGYPlatform.pdf >.</url:>			
a	"Polymer Technology: Performance Data and Design Considerations." Optical Crosslinks, Incorporated. 2001. Pages 1-9. Retrieved from internet: <url: <a="" href="http://www.opticalcrosslinks.com/pdf/WebPerformanceDataDesignTECHNOLGY.pdf">http://www.opticalcrosslinks.com/pdf/WebPerformanceDataDesignTECHNOLGY.pdf.</url:>			

EXAMINER

ag Cy

DATE CONSIDERED

03-27-07

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.